

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
Name		Execution Date
Steffen Meyer		06/26/2008
RECEIVING PARTY DATA		
Name:	Qimonda AG	
Street Address:	Gustav-Heinemann-Ring 212	
City:	Munchen	
State/Country:	GERMANY	
Postal Code:	81739	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	12129765	
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NAME OF SUBMITTER:	Mark R. Bilak	
Total Attachments: 1 source=5682040Assign#page1.tif		

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PATENT
REEL: 021200 FRAME: 0072

CLIENT REF. S4258 SB/swi
C&B REF. 5682-040**ASSIGNMENT**

For good and valuable consideration, I, Steffen Meyer, a citizen of Germany, residing at Helfenberger Strasse 6, 01277 Dresden, Germany, hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to **Qimonda AG**, having its principal place of business at Gustav-Heinemann-Ring 212, 81739 München, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and

filed on 30 May 2008

US. Serial No. 12/129,765

entitled: **Method of Forming an Integrated Circuit with NAND Flash Array Segments and Intra Array Multiplexers and Corresponding Integrated Circuit with NAND Flash Array Segments and Intra Array Multiplexers**

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE: _____

Steffen Meyer

DATE: _____

26.06.08